

DATASHEET

6 PIN DIP PHOTOTRANSISTOR PHOTOCOUPLER 4N2X Series 4N3X Series H11AX Series







Features:

- 4N2X series: 4N25, 4N26, 4N27, 4N28
- 4N3X series: 4N35, 4N36, 4N37, 4N38
- H11AX series: H11A1, H11A2, H11A3, H11A4, H11A5
- High isolation voltage between input and output (Viso=5000 V rms)
- Creepage distance >7.62 mm
- Operating temperature up to +110°C
- Compact dual-in-line package
- •The product itself will remain within RoHS compliant version •Compliance with EU REACH
- UL and cUL approved(No. E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approval
- DEMKO approval
- FIMKO approval
- CQC approved

Description

The 4N2X, 4N3X, H11AX series of devices each consist of an infrared emitting diode optically coupled to a phototransistor.

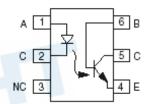
They are packaged in a 6-pin DIP package and available in wide-lead spacing and SMD option.

Applications

1

- Power supply regulators
- Digital logic inputs
- Microprocessor inputs

Schematic



Pin Configuration

- 1. Anode
- 2. Cathode
- 3. No Connection
- Emitter
- 5. Collector
- 6. Base

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Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Rating	Unit
	Forward current	I _F	60	mA
	Peak forward current (t = 10µs)	I _{FM}	1	А
Input	Reverse voltage	V _R	6	V
	Power dissipation ($T_A = 25^{\circ}C$)	D	100	mW
	Derating factor (above 100°C)	P _D	3.8	mW/°C
	Collector-Emitter voltage	V _{CEO}	80	V
	Collector-Base voltage	V _{CBO}	80	V
	Emitter-Collector voltage	V _{ECO} 7		V
Output	Emitter-Base voltage	V _{EBO}	V _{EBO} 7	
	Power dissipation ($T_A = 25^{\circ}C$)	D	150	mW
	Derating factor (above 100°C)	Pc —	9.0	mW/°C
Total Power Dissipation		Ртот	200	mW
Isolation Voltage*1		VISO	5000	V rms
Operating Temperature		T _{OPR}	-55 to 110	°C
Storage Temperature		T _{STG} -55 to 125		°C
Soldering Temperature*2		T _{SOL}	260	°C

Notes:

*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 & 3 are shorted together, and pins 4, 5 & 6 are shorted together. *2 For 10 seconds

Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input						
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	VF	-	1.2	1.5	V	I _F = 10mA
Reverse current	I _R	-	-	10	μA	$V_R = 6V$
Input capacitance	Cin	-	30	-	pF	V = 0, f = 1MHz
Output						
Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
Collector-Base dark current	Ісво	-	-	20	nA	V _{CB} = 10V
4N2X Collector- Emitter H11AX	– I _{CEO}	-	-	50	nA	V _{CE} = 10V, IF=0mA
dark current 4N3X		-	-	50		V _{CE} = 60V, IF=0mA
Collector-Emitter breakdown voltage	BV _{CEO}	80		-	V	l _c =1mA
Collector-Base breakdown voltage	ВVсво	80	-	4	V	Ic=0.1mA
Emitter-Collector breakdown voltage	BV _{ECO}	7	-	-	V	I _E =0.1mA
Emitter-Base breakdown voltage	BV _{EBO}	7	-	-	V	I _E =0.1mA
Collector-Emitter capacitance	CCE	-	8	-	pF	VCE=0V, f=1MHz

* Typical values at T_a = 25°C

Transfer Characteristics

Pa	rameter	Symbol	Min	Тур.	Max.	Unit	Condition
	4N35, 4N36, 4N37		100	-	-	%	I _F = ±10mA ,V _{CE} = 10V
	H11A1	-	50	-	-		
Current Transfer	H11A5	CTR	30	-	-		
ratio	4N25, 4N26, 4N38, H11A2, H11A3		20	-	-		
	4N27, 4N28, H11A4		10	-	-		
	4N25, 4N26, 4N27, 4N28		-	-	0.5		$I_{F} = 50 mA$, $I_{c} = 2 mA$
Collector- Emitter	4N35, 4N36, 4N37		-	-	0.3	- V	I _F = 10mA, I _c = 0.5mA
saturation voltage	H11A1,H11A2, H11A3,H11A4, H11A5	V _{CE(sat)}	-	-	0.4		
	4N38		-	-	1.0		$I_{F} = 20mA, I_{c} = 4mA$
Isolation resistance		R _{IO}	10 ¹¹	-		Ω	$V_{IO} = 500 V dc$
Input-output	capacitance	C _{IO}	-	0.2	-	pF	$V_{IO} = 0$, f = 1MHz
Turn-on time	4N25, 4N26, 4N27, 4N28, H11A1,H11A2, H11A3,H11A4, H11A5	Ton		3	10	μs	$\label{eq:V_CC} \begin{split} V_{CC} &= 10 \text{V}, \ \text{I}_{\text{F}} = 10 \text{mA}, \\ \text{R}_{\text{L}} &= 100 \Omega \\ \text{See Fig. 11} \end{split}$
	4N35, 4N36, 4N37, 4N38		-	10	12		$V_{CC} = 10V$, $I_C = 2mA$, $R_L = 100\Omega$, See Fig. 11
Turn-off time	4N25, 4N26, 4N27, 4N28, H11A1,H11A2, H11A3,H11A4, H11A5	Toff	-	3	10	μs	$\label{eq:Vcc} \begin{split} V_{CC} &= 10 \text{V}, \ \text{I}_{\text{F}} = 10 \text{mA}, \\ R_{\text{L}} &= 100 \Omega \\ \text{See Fig. 11} \end{split}$
	4N35, 4N36, 4N37, 4N38		-	9	12		V_{CC} = 10V, I _C = 2mA, R _L = 100 Ω , See Fig. 11

* Typical values at Ta = 25°C

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Typical Electro-Optical Characteristics Curves

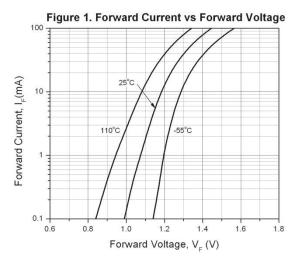
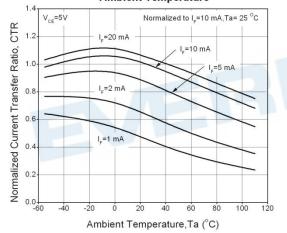
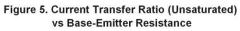
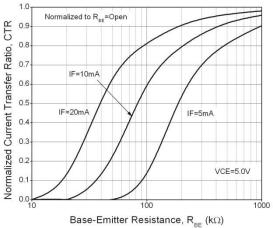


Figure 3. Current Tranfer Ratio vs Ambient Temperature







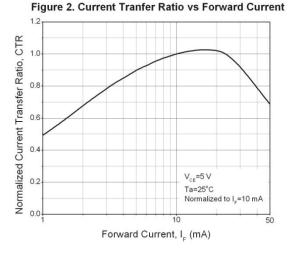
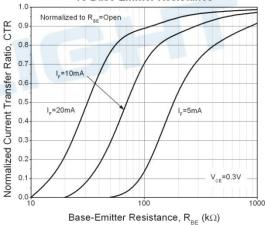


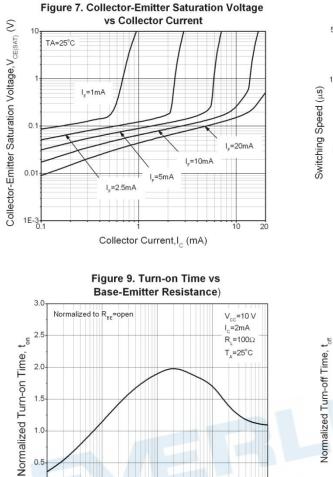
Figure 4. Current Transfer Ratio (Saturated) vs Base-Emitter Resistance



10000 V_{ce}= 10 V 1000 Collector Dark Current, I_{CEO} (nA) 100 10 0.1 0.01 1E-3 -60 120 -40 20 40 60 80 100 -20 Ambient Temperature, Ta (°C)

Figure 6. Dark Current vs Ambient Temperature

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10000

1000

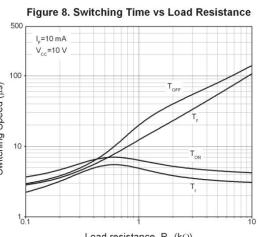
 $R_{_{BE}}$ - Base Resistance (k Ω)

100

100000

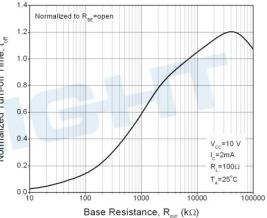
0.5

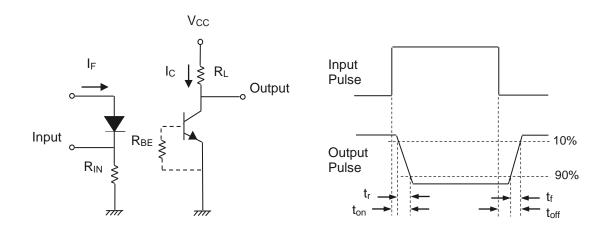
0.01

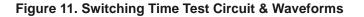


Load resistance, R, (kΩ)

Figure 10. Turn-off Time vs **Base-Emitter Resistance**



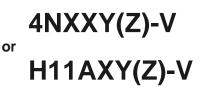






Order Information

Part Number



Note

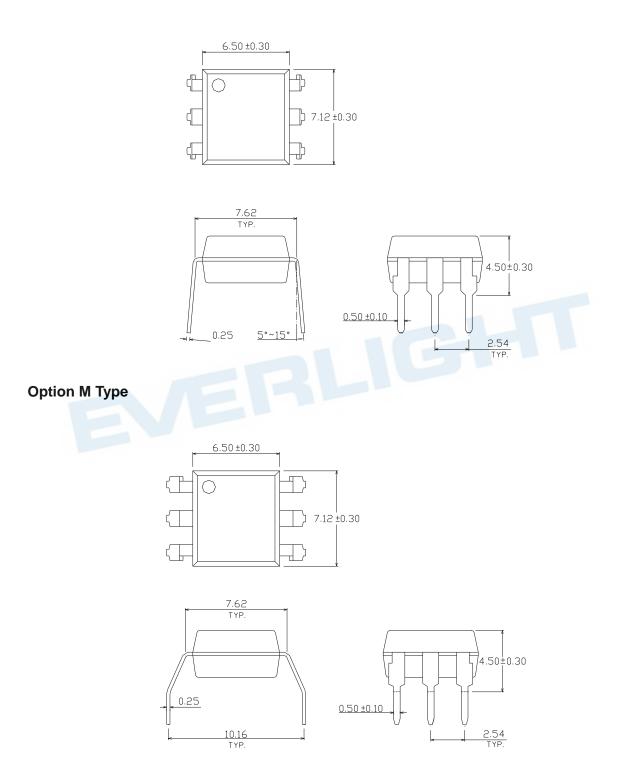
- XX = Part no. for 4NXX series (25, 26, 27, 28, 35, 36, 37 or 38)
- X = Part no. for H11AX series (1, 2, 3, 4, or 5)
- Y = Lead form option (S, S1, M or none)
- Z = Tape and reel option (TA, TB or none).
- V = VDE safety (optional)

Option	Description	Packing quantity	
None	Standard DIP-6 65 units per tube		
М	Wide lead bend (0.4 inch spacing)	65 units per tube	
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel	
S (TB)	Surface mount lead form + TB tape & reel option 1000 units per reel		
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option 1000 units per re		
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel	

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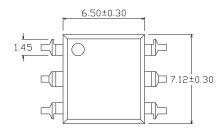
Package Dimension (Dimensions in mm)

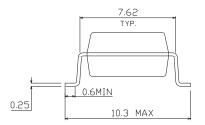
Standard DIP Type

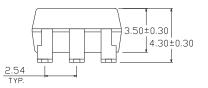


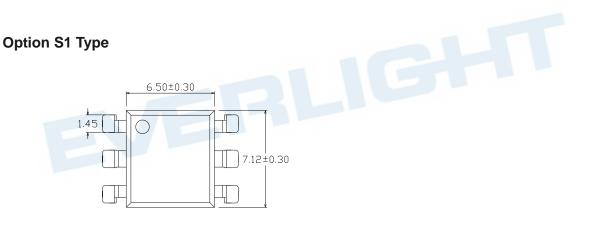


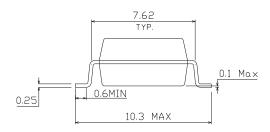
Option S Type

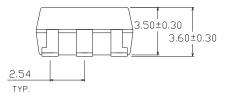






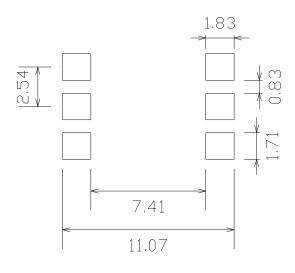








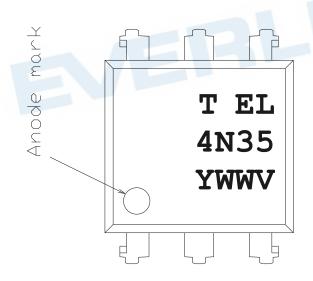
Recommended pad layout for surface mount leadform



Notes

Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Device Marking

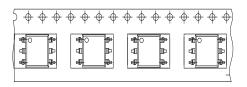


Notes

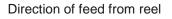
Т	denotes Factory
	No code : made in China
	T : made in Taiwan
EL	denotes Everlight
4N35	denotes Device Number
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE (optional)

Tape & Reel Packing Specifications

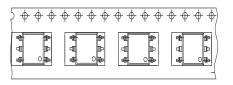
Option TA



\square



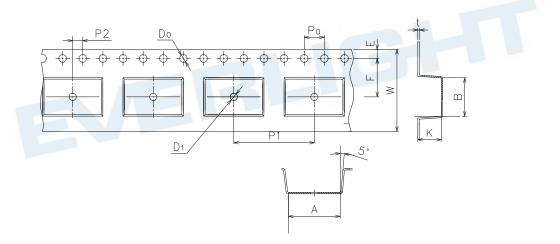
Option TB





Direction of feed from reel

Tape dimensions

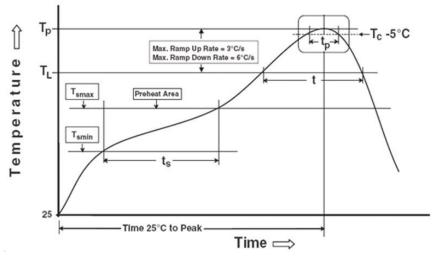


Dimension No.	Α	В	Do	D1	E	F
Dimension (mm)	10.8±0.1	7.55±0.1	1.5±0.1	1.5+0.1/-0	1.75±0.1	7.5±0.1
Dimension No.	Ро	P1	P2	t	w	к
Dimension (mm)	4.0±0.15	12±0.1	2.0±0.1	0.35±0.03	16.0±0.2	4.5±0.1



Precautions for Use

- 1. Soldering Condition
 - 1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Preheat

Temperature min (T_{smin}) Temperature max (T_{smax}) Time (T_{smin} to T_{smax}) (t_s) Average ramp-up rate (T_{smax} to T_p)

150 °C 200°C 60-120 seconds 3 °C/second max

Reference: IPC/JEDEC J-STD-020D

Other

Liquidus Temperature (TL) Time above Liquidus Temperature (tL) Peak Temperature (TP) Time within 5 °C of Actual Peak Temperature: TP - 5°C Ramp- Down Rate from Peak Temperature Time 25°C to peak temperature Reflow times 217 °C 60-100 sec 260°C 30 s 6°C /second max. 8 minutes max. 3 times

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